



### 30A TRENCH SCHOTTKY RECTIFIER

## **Product Summary**

#### SDT30B100D1

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F (MAX)</sub> (V) @ +25°C	I <sub>R (MAX)</sub> (μΑ) @ +25°C
100	30	0.85	120

## **Description and Applications**

The SDT30B100D1 provides very low  $V_F$  and extremely excellent reverse leakage stability at high temperatures. It is ideal for use as a rectifier, freewheel diode or blocking diode in:

- DC-DC Converters
- AC-DC Adaptors

### TO252 (DPAK) (Type TH)



Top View

### **Features and Benefits**

- Low Forward Voltage Drop
- Excellent High Temperature Stability
- Soft, Fast Switching Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: TO252 (DPAK) (Type TH)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Below
- Weight: 0.317 grams (Approximate)



Package Pin Out Configuration

## Ordering Information (Note 4)

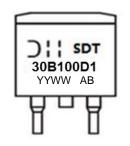
Part Number	Case	Packaging
SDT30B100D1-13	TO252 (DPAK) (Type TH)	2,500 pieces/reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**

#### TO252 (DPAK) (Type TH)



Dil = Manufacturer's Code Marking SDT30B100D1 = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week (01 to 53)



## **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm V <sub>rwm</sub> Vrm	100	٧
Average Rectified Output Current	lo	30	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	130	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	$R_{ heta JC}$	2	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C

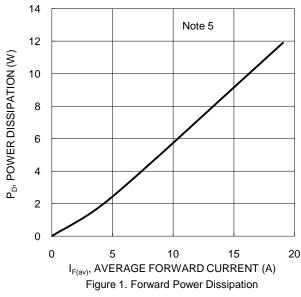
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

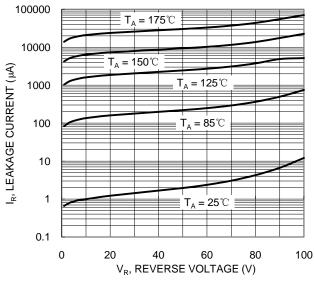
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF	111111	0.48 0.40 0.56 0.51 0.78 0.72	0.54 0.46 0.62 0.57 0.85 0.79	V	$\begin{split} I_F &= 5A, \ T_J = +25^{\circ}C \\ I_F &= 5A, \ T_J = +125^{\circ}C \\ I_F &= 10A, \ T_J = +25^{\circ}C \\ I_F &= 10A, \ T_J = +125^{\circ}C \\ I_F &= 30A, \ T_J = +25^{\circ}C \\ I_F &= 30A, \ T_J = +125^{\circ}C \\ \end{split}$
Leakage Current (Note 6)	I <sub>R</sub>	_	12 5	120 20	μA mA	$V_R = 100V, T_J = +25$ °C $V_R = 100V, T_J = +125$ °C

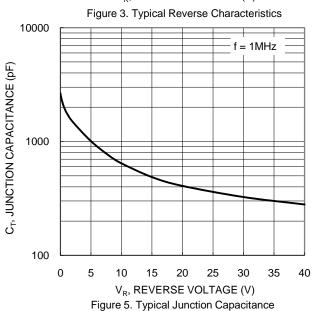
Notes:

- 5. Test with 2inch\*2inch Al board + 50mm\*50mm\*23mm Al heatsink.
- 6. Short duration pulse test used to minimize self-heating effect.









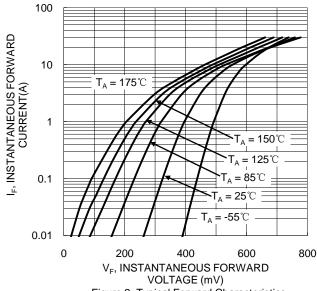


Figure 2. Typical Forward Characteristics

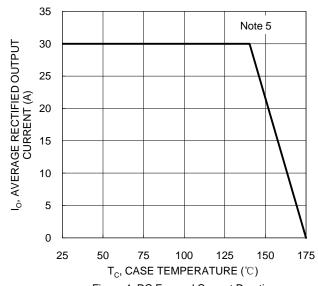
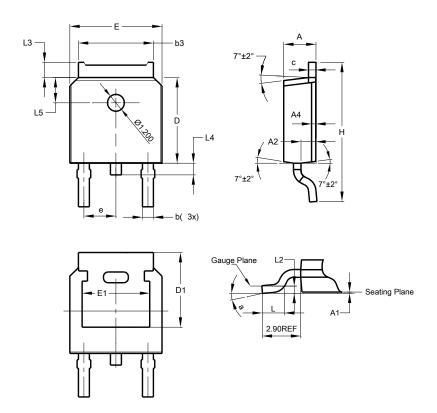


Figure 4. DC Forward Current Derating



## **Package Outline Dimensions**

### TO252 (DPAK) (Type TH)

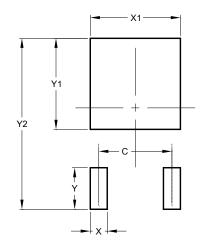


TO252 (DPAK)					
(Type TH)					
Dim	Min	Max	Тур		
Α	2.20	2.38	2.30		
A1	0.00	0.10	-		
A2	0.97	1.17	1.07		
A4	0.10 REF				
b	0.72	0.85	0.78		
b3	5.23	5.45	5.33		
C	0.47	0.58	0.53		
D	6.00	6.20	6.10		
D1	5.30 REF				
e	2.286 BSC				
E	6.50	6.70	6.60		
E1	4.70	4.92	4.83		
Н	9.90	10.10	10.30		
L	1.40	1.70	1.60		
L2	0.51 BSC				
L3	0.90	1.25	-		
L4	0.60	1.00	0.80		
L5	1.70	1.90	1.80		
а	0°	8°	-		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## TO252 (DPAK) (Type TH)



Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Υ	2.600
Y1	5.700
Y2	10.700



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